06/13/2017 504411180

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SATOSHI SHIMAMOTO	06/05/2017
YOSHIRO HIROSE	05/31/2017
HAJIME KARASAWA	05/31/2017
RYOTA HORIIKE	05/31/2017
NAOHARU NAKAISO	05/31/2017
YOSHITOMO HASHIMOTO	05/31/2017

RECEIVING PARTY DATA

Name:	HITACHI KOKUSAI ELECTRIC INC.	
Street Address:	15-12, NISHI-SHIMBASHI 2-CHOME	
Internal Address:	MINATO-KU	
City:	TOKYO	
State/Country:	JAPAN	
Postal Code:	105-8039	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15620280

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	HITACHI13-0001413US01	
NAME OF SUBMITTER:	GERALD B. HALT, JR.	
SIGNATURE:	/Gerald B. Halt, Jr./	
DATE SIGNED:	06/13/2017	

PAIENI **REEL: 042695 FRAME: 0390** 504411180

Total Attachments: 8 source=A_HITACHI13_0001413US01_Assignment_EFS#page1.tif source=A_HITACHI13_0001413US01_Assignment_EFS#page2.tif source=A_HITACHI13_0001413US01_Assignment_EFS#page3.tif source=A_HITACHI13_0001413US01_Assignment_EFS#page4.tif source=A_HITACHI13_0001413US01_Assignment_EFS#page5.tif source=A_HITACHI13_0001413US01_Assignment_EFS#page6.tif source=A_HITACHI13_0001413US01_Assignment_EFS#page7.tif source=A_HITACHI13_0001413US01_Assignment_EFS#page8.tif

PATENT REEL: 042695 FRAME: 0391

ASSIGNMENT AND DECLARATION

With respect to the invention titled

METHOD OF MANUFACTURING SEMICONDUCTOR DEVICE, SUBSTRATE PROCESSING APPARATUS, AND RECORDING MEDIUM

for which the undersi	gned has authorized or prepared an application for United
States Letters Patent,	U.S. Patent Application No, filed on
I (the undersign	ed) hereby state the following.
The above-ident	DECLARATION ified application was made or authorized to be made by me.
	am the original inventor or an original joint inventor of a
claimed invention in th	
	ed and understand the contents of the above-identified
application, including	
	the duty to disclose information which is material to
	d in Title 37, Code of Federal Regulations § 1.56.
I hereby ackno	wledge that any willful false statement made in this
	able under 18 U.S.C. 1001 by fine or imprisonment of not
more than 5 years, or l	
	Assignment
The undersigned	d hereby authorizes assignee or assignee's representative to
insert the Application	Number and the filing date of this application if they are
unknown at the time o	f execution of this assignment.
Assignee	HITACHI KOKUSAI ELECTRIC INC.
Assignee State or Country of Incorporation	Japan
Assignee Address	15-12, Nishi-shimbashi 2-chome, Minato-ku
,	Tokyo 1058039, Japan

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Assignee is desirous of acquiring the entire right, title and interest in the invention, all applications for and all letters patent issued on the invention.

For good and valuable consideration, the receipt and sufficiency of which is acknowledged, the undersigned, intending to be legally bound, does hereby sell, assign and transfer to the assignee and assignee's successors, assigns and legal representatives the entire right, title and interest in the invention and all patent applications thereon, including, but not limited to, the application for United States Letters Patent entitled as above, and all divisions and continuations thereof, and in all letters patent, including all reissues and reexaminations thereof, throughout the world, including the right to claim priority under the Paris Convention or other treaty.

It is agreed that the undersigned shall be legally bound, upon request of the assignee, to supply all information and evidence relating to the making and practice of the invention, to testify in any legal proceeding relating thereto, to execute all instruments proper to patent the invention throughout the world for the benefit of the assignee, and to execute all instruments proper to carry out the intent of this instrument.

The undersigned warrants that the rights and property herein conveyed are free and clear of any encumbrance.

AND this Assignment may be executed in multiple counterparts, each of which shall be deemed to be an original of this Assignment. Additionally, the undersigned hereby authorizes our attorneys to collect the signature pages of each executed counterpart and to attach those signature pages to a single copy of this instrument, which single copy and attached signature pages together shall constitute an original of this Assignment.

SIGNATURE SHEET FOR DECLARATION AND ASSIGNMENT

inventor's Name	SHIMAMOTO, Satoshi	
inventor's Signature	- Nimmto Salodi Juno 5, 2017	
Date	June 5, 2017	
Signed at	Toyama-shi, Japan	
	(City and Country) .	
STATEM	MENT OF WITNESS (optional):	
	ı,	
	Name of Witness	
was pers	sonally present and did see SHIMAMOTO, Satoshi	
-	inventor identified above	
execute t	this Assignment on and such Assignor is persona known	ılly
	date	
to me to l	be the person described herein.	
Witness Signature		
An applica	ation data sheet (PTO/SB/14 or equivalent), including naming the entire inventiv	e entit

An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use a separate form for each inventor; or check the box below and complete the attached page(s) to list additional inventors.

■ Additional inventors are being named on the <u>5</u> supplemental sheet(s) attached hereto.

Inventor's Name	HIROSE, Yoshiro	
Inventor's Signature	Hirose, Yos	hiro
Date	May 31	7105,
Signed at	Toyama-shi, Japan	
_	(City and Country)	
STATEME	ENT OF WITNESS (option	mal):
	Ι,	
		Name of Witness
was person	nally present and did see	HIROSE, Yoshiro
	·	inventor identified above
execute th	is Assignment on	and such Assignor is personally known
	***	***
to me to be	e the person described here	in.
Witness Signature		

KARASAWA, Hajime	
KARASAWA, Hajime	
May 31, 2017	
Toyama-shi, Japan	
(City and Country)	
ENT OF WITNESS (optional):	
I,	
N	ame of Witness
onally present and did seeKARASAWA	, Hajime
inventor iden	tified above
his Assignment on and know date	such Assignor is personally vn
pe the person described herein.	
) h	HAFASAWA, Hajime May 31, 2017 Toyama-shi, Japan (City and Country) ENT OF WITNESS (optional): I, Note that the properties of the pro

Inventor's Name	IIORIIKE, Ryota	
Inventor's Signature	HORLIKE, Ryo	<u>tc</u>
Date	May 31, 2017	7
Signed at	Toyama-shi, Japan	
-	(City and Country)	
STATEMI	ENT OF WITNESS (option	onal):
	Ι,	
		Name of Witness
was perso	nally present and did see	HORIIKE, Ryota
		inventor identified above
execute th	ais Assignment on	and such Assignor is personally known
	ū	
to me to be	e the person described here	ein.
Witness Signature		

inventor's Name	NAKAISO, Naoharu	
Inventor's Signature	NAKAISO, N May 31, 2	Vaoharu
Date	May 31, 2	017
Signed at	Toyama-shi, Japan	
•	(City and Country)	
STATEMI	ENT OF WITNESS (option	onal):
	I,	
		Name of Witness
was perso	mally present and did see	NAKAISO, Naoharu
	•	inventor identified above
execute th	nis Assignment on	and such Assignor is personally known
	d	ate
to me to b	e the person described here	ein.
Witness Signature		

Inventor's Name	HASHIMOTO, Yoshitom	0
Inventor's Signature	HASHIMOTO, You	shitomo
Date	May 31, 2017	
Signed at	Toyama-shi, Japan	
	(City and Country)	
STATEM	ENT OF WITNESS (option	nal):
	Ι,	
		Name of Witness
was perso	onally present and did see	HASHIMOTO, Yoshitomo
	i	inventor identified above
execute tl	his Assignment onda	and such Assignor is personally known
to me to b	e the person described herei	n.
Witness Signature		